LONGTECH OPTICS

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SPECIFICATIONS OF LCD MODULE

MODULE NO: LGC12864E-FSW-FTW

DOC.REVISION: 00

	SIGNATURE	DATE
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1. Features

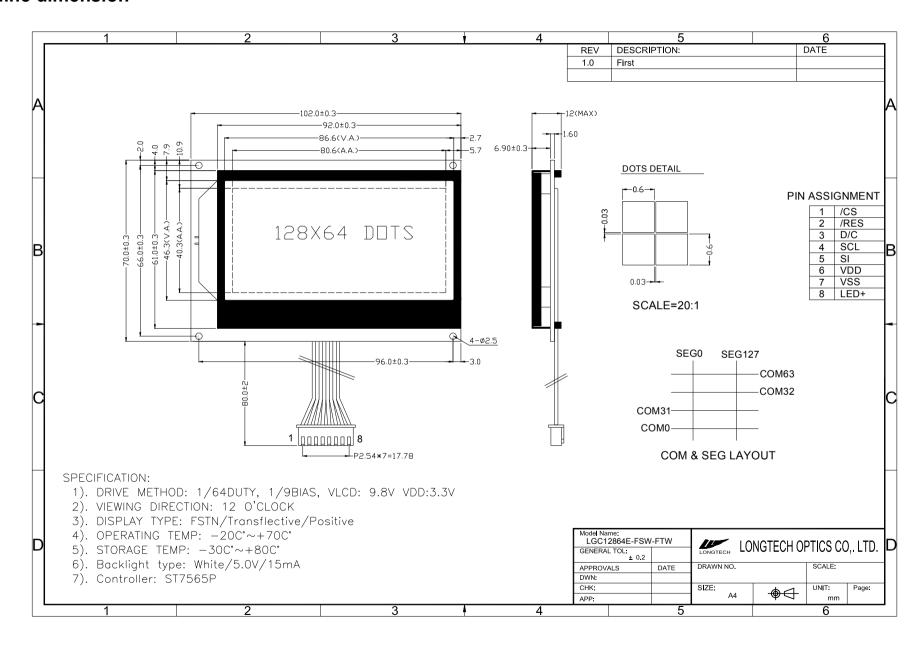
- 1. 128*64 dots
- 2. 80 or 68 MPU interfaces
- 3. Built-in controller (ST7565P)
- 4. Display Mode & Backlight Variations
 5. ROHS Compliant

	□TN							
LCD type	☑FSTN	□FSTI	□FSTN Negative					
	□STN Yellow 0	Green	□STN	Gray			□STN Blue	Negative
View direction	□6 O'clock		☑12 O	☑12 O'clock				
Rear Polarizer	□Reflective		⊠Tran	☑Transflective			□Transmissive	
Backlight Type	☑LED Edge	□EL	•	□Internal Power		☑3.0V Input		
Backlight Type	□LED Array	□CCF	L	☑External Power		□5.0V Input		
Backlight Color	☑White	□ Blue	;	☐ Amber		□Yellow-Green		
Temperature Range	□Normal		☑Wide	☑Wide			□Super Wide	
DC to DC circuit	☑Build-in	☑Build-in			□Not Build-in			
Touch screen	□With				☑Without			
Font type	□English-Japa	nese	□Englis	llish-European □English-Russian ☑		☑other		

2. MECHANICAL SPECIFICATIONS

Module size	102.0mm(L)*70.0mm(W)* 12.0(H)mm
Viewing area	86.6mm(L)*46.3mm(W)
Dots size	0.6mm(L)*0.6mm(W)
Dots pitch	0.63mm(L)*0.63mm(W)
Weight	Approx.

3. Outline dimension



4. Absolute maximum ratings

ltem	Symbol	Standard		Unit	
Power voltage	V _{DD} -V _{SS}	0	-	3.5	M
Input voltage	V _{IN}	VSS	-	VDD	V
Operating temperature range	V _{OP}	-20	-	+70	°C
Storage temperature range	V _{ST}	-30	-	+80	

5.Interface pin description

Pin no.	Symbol	External connection	Function				
1	Vss	Dower aupply	Power supply for LCM (GND)				
2	V_{DD}	Power supply	Signal ground for logic (+3.3V)				
3	NC						
4	/RESET	MPU	Controller reset (module reset)				
5	/CS	MPU	Used to enter chip select signal				
6	A0	MPU	Register select signal				
7~14	V_{DD}	Power supply	Power supply for logic (+3.3V) for LCM				
15	SCL	MPU	Serial clock input				
16	SI	MPU	Serial data input				
17	А	Power supply for	Power supply for BKL (+4.2V)				
18	K	BKL	Signal ground				

3. Optical characteristics

STN type display module (Ta=25°C, VDD=3.3V)

ltem	Symbol	Condition	Min.	Тур.	Max.	Unit
Viewing angle	θ	Cr≥2	-60	-	35	dog
	Ф	Or≠∠	-40	-	40	deg
Contrast ratio	C_r		-	6	-	-
Response time (rise)	T_r	-	-	150	250	me
Response time (fall)	Tr	1	-	150	250	ms

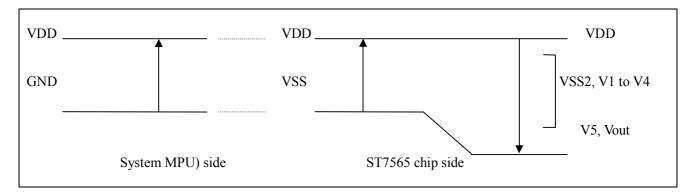
7. Electrical characteristics

DC characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply voltage for LCD	V_{DD} - V_0	Ta =25℃	-	9.8	-	V
Input voltage	V_{DD}		2.4	-	3.3	
Supply current	I _{DD}	Ta=25℃, V _{DD} =3.3V	-	-	147	uA
Input leakage current	ILKG		-	-	1.0	uA
"H" level input voltage	VIH		2.2	-	V _{DD}	
"L" level input voltage	VIL	Twice initial value or less	0	-	0.6	
"H" level output voltage	Vон	LOH=-0.5mA	2.4	-	-	V
"L" level output voltage	Vol	LOH=0.5mA	-	-	0.4	
Backlight supply voltage	VF		-	4.2	-	
Backlight supply current	I _{LED}	V _F =4.2V	-	80	-	mA

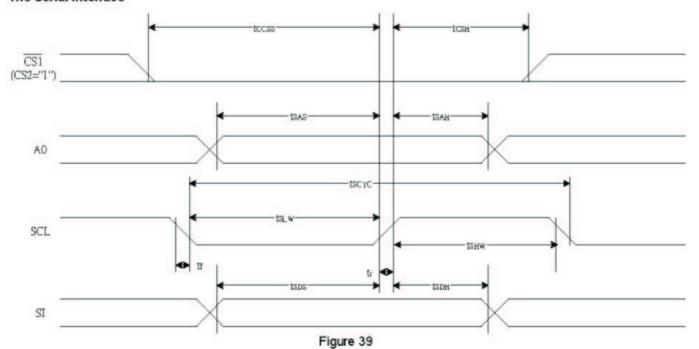
8. Absolute Maximum Ratings (Unless otherwise noted, VSS=0V)

Paran	neter	Symbol	Conditions	Unit
Power Supply Voltage		VDD	-0.3 to +3.6	V
Power supply voltage (3) (V	/DD standard)	V5, Vout	-13.0 to +0.3	V
Power supply voltage (4) (VDD standard)		V1,V2,V3,V4	V5 to +0.3	V
Input Voltage		Vin	-0.3 to VDD+0.3	V
Output voltage	Output voltage		-0.3 to VDD+0.3	V
Operating Temp.		Topr	-40 to 80	С
Storage Temp.	Bare chip	Tstr	-40 to +80	C



9. Timing Characteristics

The Serial Interface



n = year

Table 30 $(V_{DD} = 3.3V, Ta = -30 \text{ to } 85^{\circ}\text{C})$

Item	Cianal	Symbol	Condition	Rat	ing	Units
item	Signal	Symbol	Condition	Min.	Max.	Units
Serial Clock Period		Тѕсус		50	-	
SCL "H" pulse width	SCL	Tshw		25	_	
SCL "L" pulse width		TSLW		25	_	7
Address setup time	SCL To	TSAS		20	_	ns
Address hold time		Tsah		10	_	
Data setup time		Tsds		20	-	7
Data hold time	A0 TS	TSDH		10	_	7
CS-SCL time		Tess		20	_	
CS-SCL time	CS	Tesh		40	_	7

Table 31

(VDD = 2.7V, Ta = -30 to 85°C)

Item	Cianal	Symbol	Condition	Rat	ing	Units
item	Signal	Symbol	Condition	Min.	Max.	Onits
Serial Clock Period		Tscyc		100	_	
SCL "H" pulse width	SCL T	Tshw		50	_	
SCL "L" pulse width		TSLW		50	_	7
Address setup time	SCL	TSAS	3	30	-	1
Address hold time		TSAH		20	_	ns
Data setup time	SCL TSI TSI A0 TSI SI TSI	TSDS		30	_	7
Data hold time		TSDH		20	-	7
CS-SCL time	66	Toss		30	_	7
CS-SCL time	CS	TCSH		60		7

10. Table of LCM commands

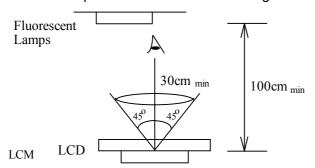
Command	Command Code						Function					
Command	A0	/RD	/WR	D7	D6	D5	D4	D3	D2	D1	D0	Function
(1) Display ON/OFF	0	1	0	1	0	1	0	1	1	1	0	LCD display ON/OFF 0: OFF, 1: ON
(2) Display start line set	0	1	0	0	1	D	ispla	ay st	art a	ddre	ess	Sets the display RAM display star line address
(3) Page address set	0	1	0	1	0	1	1	Pa	ige a	ddr	ess	Sets the display RAM page address
(4) Column address set upper bit Column address set lower bit	0	1	0	0	0	0	0	Lea	umn ast s	add ignif	cant fress ficant fress	Sets the most significant 4 bits of the display RAM column address Sets the least significant 4 bits of the display RAM column address
(5) Status read	0	0	1		St	atus		0	0	0	0	Reads the status data
(6) Display data write	1	1	0			- 1	Writ	e da	ta			Writes to the display RAM
(7) Display data read	1	0	1				Rea	d da	ta			Reads from the display RAM
(8) ADC select	0	1	0	1	0	1	0	0	0	0	0	Sets the display RAM address SEG output correspondence 0: normal, 1: reverse
(9) Display normal/ reverse	0	1	0	1	0	1	0	0	1	1	0	Sets the LCD display normal/ reverse 0: normal, 1: reverse
(10) Display all points ON/OFF	0	1	0	1	0	1	0	0	1	0	0	Display all points 0: normal display 1: all points ON
(11) LCD bias set	0	1	0	1	0	1	0	0	0	1	0	Sets the LCD drive voltage bias ratio 0: 1/9 bias, 1: 1/7 bias (ST7565P
(12) Read/modify/write	0	1	0	1	1	1	0	0	0	0	0	Column address increment At write: +1 At read: 0
(13) End	0	1	0	1	1	1	0	1	1	1	0	Clear read/modify/write
(14) Reset	0	1	0	1	1	1	0	0	0	1	0	Internal reset
(15) Common output mode select	0	1	0	1	1	0	0	0	*	*	*	Select COM output scan direction 0: normal direction 1: reverse direction
(16) Power control set	0	1	0	0	0	1	0	1		era ode	ting	Select internal power supply operating mode
(17) Vo voltage regulator internal resistor ratio set	0	1	0	0	0	1	0	0		sist	or	Select internal resistor ratio(Rb/Ra) mode
(18) Electronic volume mode set Electronic volume register set	0	1	0	1 0	0	0 Ele	0 ctro	0 nic v	0 /olur	0 ne v	1 /alue	Set the Vo output voltage electronic volume register
(19) Static indicator ON/OFF Static indicator	0	1	0	1 0	0	1 0	0	1	1	0	0 1 Mode	0: OFF, 1: ON Set the flashing mode
register set (20) Booster ratio set	0	1	0	1 0	1 0	1 0	1 0	1	0	0 ste	0 p-up ilue	select booster ratio 00: 2x,3x,4x 01: 5x 11: 6x
(21) Power saver												Display OFF and display all points ON compound command
(22) NOP	0	1	0	1	1	1	0	0	0	1	1	Command for non-operation
(23) Test	0	1	0	1	1	1	1	*	*	*	*	Command for IC test. Do not use this command

11.QUALITY SPECIFICATIONS

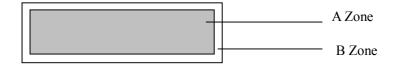
11.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: Active display area (minimum viewing area).

B Zone: Non-active display area (outside viewing area).

11.2 Specification of quality assurance AQL inspection standard

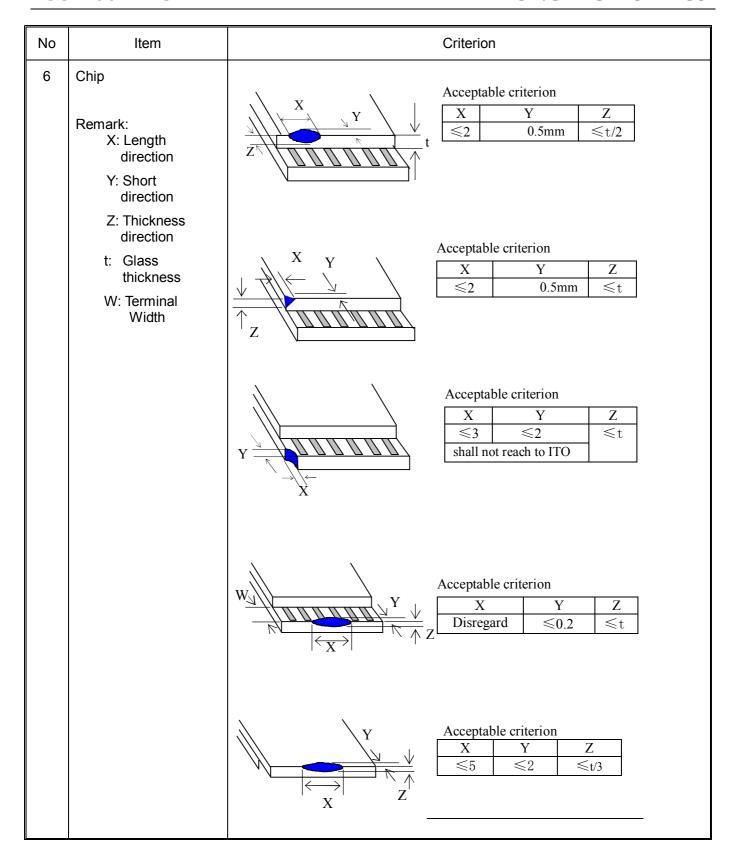
Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification (Note: * is not including)

Classify		Item	Note	AQL
Major	Major Display state Short or open circuit		1	0.65
		LC leakage		
		Flickering		
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display	Background color deviation	2	1.0
	state	Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
		Protruded	12	
	Polarizer	Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	

Note on defect classification

No.	Item	Crite	rion					
1	Short or open circuit	Not allow						
	LC leakage							
	Flickering							
	No display							
	Wrong viewing direction							
	Wrong Back-light							
2	Contrast defect	Refer to approval sample						
	Background color deviation							
3	Point defect, Black spot, dust (including Polarizer) $\phi = (X+Y)/2$	Point Size $ \frac{\phi \leq 0.10}{0.10 < \phi \leq 0.} $ $ 0.20 < \phi \leq 0. $ $0.25 < \phi \leq 0. $ $\phi > 0.30$	25 2					
4	Line defect, Scratch	$ \begin{array}{c c} & \downarrow \\ & \downarrow \\$	V 2 V 1					
5	Rainbow	Not more than two color changes a	ore than two color changes across the viewing area.					



No.	Item	Criterion				
7	Segment pattern W = Segment width φ = (X+Y)/2	(1) Pin hole φ < 0.10mm is acceptable.				
		Y Point Size Acceptable Qty $ \phi \leqslant 1/4W \qquad \text{Disregard} \\ 1/4W < \phi \leqslant 1/2W \qquad 1 $ $ \phi > 1/2W \qquad 0 $				
		Unit: mm				
8	Back-light	(1) The color of backlight should correspond its specification.				
9	Soldering	(2) Not allow flickering (1) Not allow heavy dirty and solder ball on PCB. (The size of dirty refer to point and dust defect) (2) Over 50% of lead should be soldered on Land. Lead Land 50% lead				
10	Wire	(1) Copper wire should not be rusted(2) Not allow crack on copper wire connection.(3) Not allow reversing the position of the flat cable.(4) Not allow exposed copper wire inside the flat cable.				
11*	PCB	(1) Not allow screw rust or damage. (2) Not allow missing or wrong putting of component.				

No	Item	Criterion				
12	Protruded W: Terminal Width	Acceptable criteria: $Y \le 0.4$				
13	TAB	1. Position W W1 ≤ 1/3W H1 ≤ 1/3H 2 TAB bonding strength test TAB P (=F/TAB bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)				
14	Total no. of acceptable Defect	A. Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm B. Zone It is acceptable when it is no trouble for quality and assembly in customer's end product.				

11.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80°C	48	
High temp. Operating	70°C	48	No abnormalities
Low temp. Storage	-30°C	48	in functions
Low temp. Operating	-20°C	48	and appearance
Humidity	40°C/ 90%RH	48	
Temp. Cycle	0° C ← 25° C → 50° C (30 min ← 5 min → 30min)	10cycles	

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (20+8°C), normal humidity (below 65% RH), and in the area not exposed to direct sun light.

11.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- Do not make any modification on the PCB without consulting LONGTECH
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and

the interface terminals with any parts of the human body.

- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280°C+10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

LONGTECH LCDs and modules are not consumer products, but may be incorporated by LONGTECH's customers into consumer products or components thereof, LONGTECH does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of LONGTECH is limited to repair or replacement on the terms set forth below. LONGTECH will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between LONGTECH and the customer, LONGTECH will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with LONGTECH general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.